

TRADEMARK ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

| | | | |
|--|--|----------------|----------------------|
| SUBMISSION TYPE: | NEW ASSIGNMENT | | |
| NATURE OF CONVEYANCE: | ASSIGNS THE ENTIRE INTEREST AND THE GOODWILL | | |
| CONVEYING PARTY DATA | | | |
| Name | Formerly | Execution Date | Entity Type |
| TPACK AS | | 03/23/2011 | CORPORATION: DENMARK |
| RECEIVING PARTY DATA | | | |
| Name: | APPLIED MICRO CIRCUITS CORPORATION | | |
| Street Address: | 215 Moffett Park Drive | | |
| City: | Sunnyvale | | |
| State/Country: | CALIFORNIA | | |
| Postal Code: | 94089 | | |
| Entity Type: | CORPORATION: DELAWARE | | |
| PROPERTY NUMBERS Total: 1 | | | |
| Property Type | Number | Word Mark | |
| Registration Number: | 3864902 | SOFTSILICON | |
| CORRESPONDENCE DATA | | | |
| Fax Number: | (650)815-2601 | | |
| | <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> | | |
| Phone: | 650-815-2600 | | |
| Email: | svtmdocketing@sheppardmullin.com | | |
| Correspondent Name: | Harold Milstein | | |
| Address Line 1: | 390 Lytton Avenue | | |
| Address Line 4: | Palo Alto, CALIFORNIA 94301 | | |
| ATTORNEY DOCKET NUMBER: | 23NS-152456 | | |
| NAME OF SUBMITTER: | Harold Milstein | | |
| Signature: | /HaroldMilstein/ | | |
| Date: | 03/31/2011 | | |
| Total Attachments: 1 source=DOC#page1.tif | | | |

CH \$40.00 3864902

USA

TRADEMARK ASSIGNMENT

WHEREAS, TPACK A/S, a Danish corporation, located at Hørkær 12A, DK-2730 Herlev, Denmark, has adopted, is using or has an intent-to-use and is the owner of the following trademarks with registrations or applications in the United States (the "Trademarks");

Registration Number 3602586 – TPACK (stylized)

Registration Number 3864902 - SOFTSILICON

WHEREAS, Applied Micro Circuits Corporation, a Delaware corporation, located at 215 Moffett Park Drive, Sunnyvale, CA 94089 U.S.A., is desirous of acquiring said Trademarks and the registrations or applications thereof as successor in interest to the business pertaining to the Trademarks;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, TPACK A/S does hereby assign unto Applied Micro Circuits Corporation all its right, title and interest in and to said Trademarks, together with the goodwill of the business symbolized by the marks, and the registrations and applications thereof.

Date: 3/22/11

TPACK A/S

By: Robert Gargus

Name: Robert Gargus

Title: Chairman of the Board of Directors

Date: 3/23/11

TPACK A/S

By: Colin Macnab

Name: Colin Macnab

Title: President